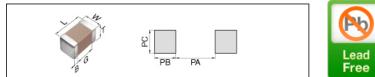
Creation Date : January 05, 2015

## C3216X7R1A106M160AC (TDK item description : C3216X7R1A106MT\*\*\*\*)

Applications Commercial Grade

Feature General (Up to 50V)

Series C3216 [EIA CC1206]









Size		
Length(L)	3.20mm +/-0.20mm	
Width(W)	1.60mm +/-0.20mm	
Thickness(T)	1.60mm +/-0.20mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	1.00mm Min.	
Recommended Land Pattern(PA)	2.10 to 2.50mm (Flow Soldering) < br /> 2.00 to 2.40mm (F	Reflow Soldering
Recommended Land Pattern(PB)	1.10 to 1.30mm (Flow Soldering) < br />1.00 to 1.20mm (F	Reflow Soldering
Recommended Land Pattern(PC)	1.00 to 1.30mm (Flow Soldering) < br />1.10 to 1.60mm (F	Reflow Soldering
Recommended Slit Pattern(SD)		

Electrical Characteristics		
Capacitance	10uF +/-20%	
Rated Voltage	10Vdc	
Temperature Characteristic	X7R(+/-15%)	
Dissipation Factor	5% Max.	
Insulation Resistance	10MΩ Min.	

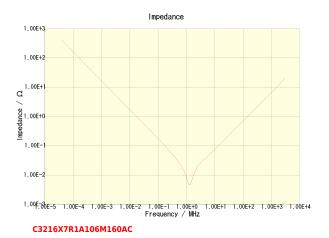
Other		
Soldering Method	Reflow, Flow	
AEC Q200	No	
Packing	Blister (Plastic)Taping [180mm Reel]	
Package Quantity	2000Pcs Min.	

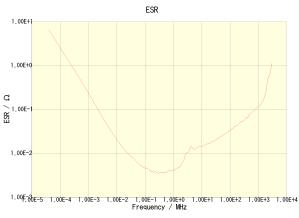
<sup>•</sup>This PDF document was created based on the data listed on the TDK Corporation website.

<sup>•</sup>All specifications are subject to change without notice.

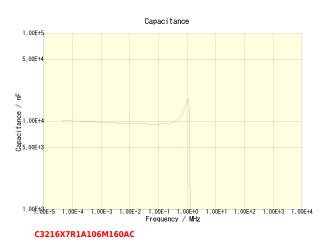
## C3216X7R1A106M160AC

## Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



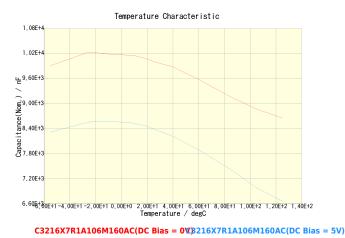


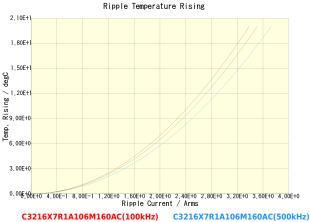






C3216X7R1A106M160AC





C3216X7R1A106M160AC(1MHz)

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